

Maximum Ratings - Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Nate 7) \/ 4.5\/	Steady State	T _A = +25°C T _A = +70°C	ID	1,030 800	mA
Continuous Drain Current (Note 7) $V_{GS} = 4.5V$	t<10s	T _A = +25°C T _A = +70°C	ID	1,150 900	mA
Continuous Drain Current (Note 7) V _{GS} = 1.8V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	740 570	mA
	t<10s	T _A = +25°C T _A = +70°C	ID	870 700	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			IDM	3	А
Maximum Body Diode Continuous Current			ls	800	mA

Maximum Ratings - Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±12	V
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-700 -550	mA
Continuous Drain Current (Note 7) $V_{GS} = -4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-820 -640	mA
Continuous Drain Current (Nate 7) \/ 19)/	Steady State	T _A = +25°C T _A = +70°C	lD	-460 -350	mA
Continuous Drain Current (Note 7) $V_{GS} = -1.8V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-550 -420	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	-2	A
Maximum Body Diode Continuous Current			Is	-800	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	PD	0.45	W	
Thermal Desistance, Junction to Ambient (Note 6)	Steady State	Devi	281	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	Reja	210	°C/W
Total Power Dissipation (Note 7)		PD	1	W
Thermal Desistance, Junction to Ambient (Note 7)	Steady State	Devi	129	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	Reja	97	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

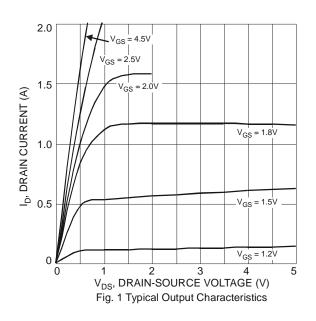
Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

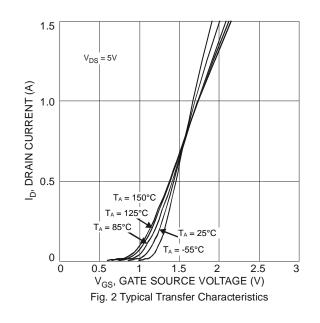


Electrical Characteristics - Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

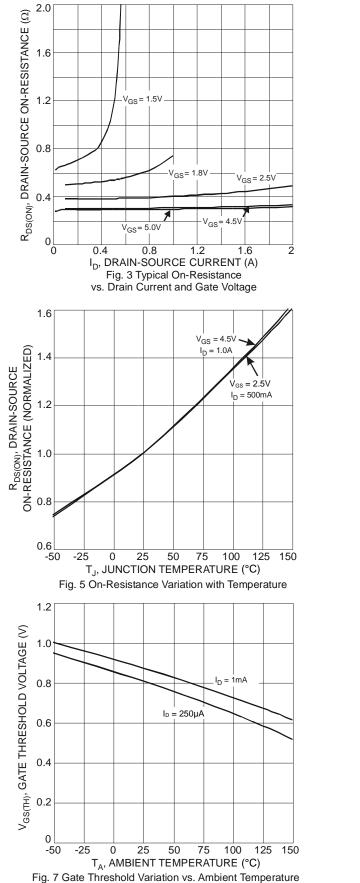
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						•
Drain-Source Breakdown Voltage	BVDSS	20	—		V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
		_	—	±1.0	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
Gate-Source Leakage	lgss	_	—	±10.0		$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)			•	•	•	
Gate Threshold Voltage	Vgs(th)	0.5	_	0.9	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	0.3	0.48	Ω	Vgs = 5.0V, ID = 200mA
		_	0.35	0.5		$V_{GS} = 4.5V, I_{D} = 200mA$
Static Drain-Source On-Resistance		_	0.45	0.7		Vgs = 2.5V, ID = 200mA
	R _{DS(ON)}	_	0.55	0.9		Vgs = 1.8V, Ip = 100mA
		_	0.65	1.5		Vgs = 1.5V, Ip = 50mA
		_	2			Vgs = 1.2V, ID = 1mA
Diode Forward Voltage	Vsd	_	0.7	1.2	V	Vgs = 0V, Is = 500mA
DYNAMIC CHARACTERISTICS (Note 9)			•	•	•	
Input Capacitance	C _{iss}	_	37.1	_		$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Output Capacitance	Coss	_	6.5	_	pF	
Reverse Transfer Capacitance	C _{rss}	—	4.8	_		
Gate Resistance	Rg	_	68	_	Ω	$V_{DS} = 0V, V_{GS} = 0V,$
Total Gate Charge	Qg	_	0.5	_		$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Source Charge	Qgs	_	0.07	_	nC	
Gate-Drain Charge	Q _{gd}	_	0.1	_		
Turn-On Delay Time	tD(ON)	_	4.06	_		
Turn-On Rise Time	tR	—	7.28	—	1	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	—	13.74	—	ns	$R_{L} = 47\Omega, R_{G} = 10\Omega,$ $I_{D} = 200 \text{mA}$
Turn-Off Fall Time	tF	_	10.54	_		ID = 200 mA

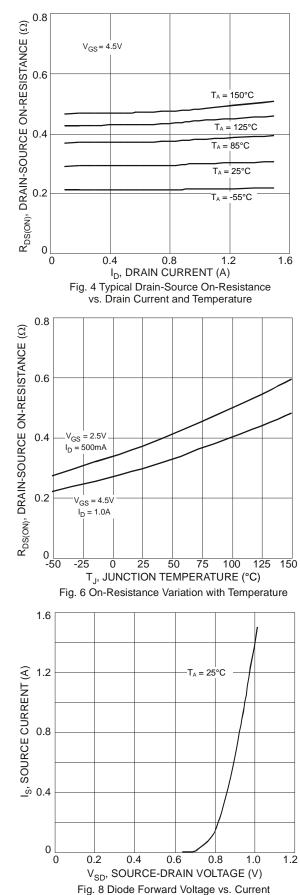
Notes:8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing.





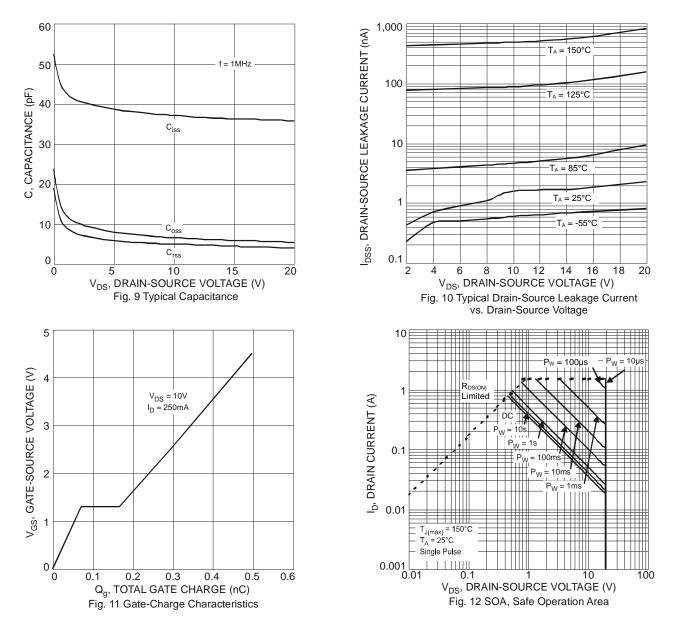








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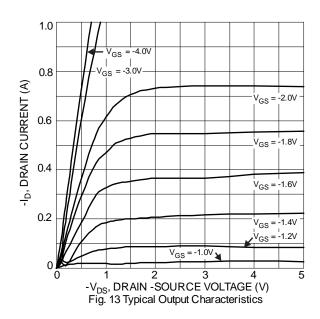


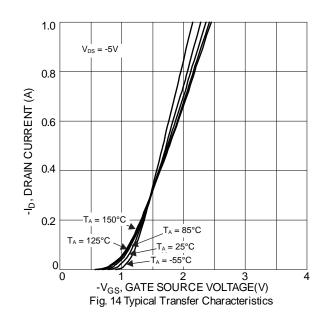


Electrical Characteristics - Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	-20	—	—	V	$V_{GS} = 0V, I_D = -1mA$
Zero Gate Voltage Drain Current TJ = 25°C	IDSS	—	—	-100	nA	V _{DS} = -20V, V _{GS} = 0V
		_	—	±1.0	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
Gate-Source Leakage	IGSS	_	—	±10.0		$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	VGS(TH)	-0.5	—	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
		—	0.67	0.97	Ω	$V_{GS} = -5V, I_{D} = -100mA$
		_	0.7	1.0		$V_{GS} = -4.5V, I_D = -100mA$
Static Drain-Source On-Resistance	Deserve	_	0.9	1.5		V _{GS} = -2.5V, I _D = -80mA
Static Drain-Source On-Resistance	RDS(ON)	_	1.2	2.0		$V_{GS} = -1.8V, I_D = -40mA$
		_	1.5	3.0		V _{GS} = -1.5V, I _D = -30mA
		_	5	—		VGS = -1.2V, ID = -1mA
Diode Forward Voltage	V _{SD}	_	-0.75	-1.2	V	$V_{GS} = 0V, I_{S} = -330mA$
DYNAMIC CHARACTERISTICS (Note 9)						*
Input Capacitance	Ciss	—	46.1	_		V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	Coss	—	7.2	—	pF	
Reverse Transfer Capacitance	Crss	—	4.9	_		
Gate Resistance	Rg	_	14.3		Ω	$V_{DS} = 0V, V_{GS} = 0V$
Total Gate Charge V _{GS} = -4.5V	Qg	_	0.5	_		
Total Gate Charge V _{GS} = -10V	Qg	—	0.85	—	nC)/ 10)/ I= 250mA
Gate-Source Charge	Qgs	—	0.09			$V_{DS} = -10V, I_D = -250mA$
Gate-Drain Charge	Qgd		0.09			
Turn-On Delay Time	t _{D(ON)}	—	8.5			$V_{DD} = -3V, V_{GS} = -2.5V,$
Turn-On Rise Time	tR		4.3		ns	
Turn-Off Delay Time	t _{D(OFF)}	_	20.2	_		$R_{L} = 300\Omega, R_{G} = 25\Omega,$
Turn-Off Fall Time	tF		19.2	_	1	I _D = -100mA

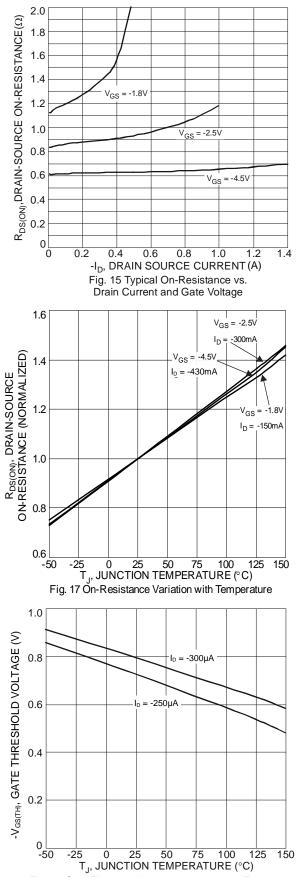
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10 $R_{D\,S(ON)},$ DRAIN-SOURCE ON-RE SISTANCE($\Omega)$ V_{GS} = -4.5V 150°C Τ_Α 125°C 85°C = 25°C = -55°C 0.1 0.01 0.1 10 -ID, DRAIN SOURCE CURRENT (A) Fig. 16 Typical On-Resistance vs. Drain Current and Temperature 2.0 $R_{D\,S(ON)},$ DRAIN-SOURCE ON-RESISTANCE (Ω) 1.5 V_{GS} = -1.8V I_D = -150mA V_{GS} = -2.5V 1.0 -300mA = Ь $V_{GS} = -4.5V$ -430mA 0.5 0 25 0 25 50 75 100 12 T_J, JUNCTION TEMPERATURE (°C) -50 -25 125 150 Fig. 18 On-Resistance vs.Temperature 1.0 0.8 -I_S, SOURCE CURRENT (A) 0.6 T_A = 25°C 0.4 0.2 0 0 0.2 0.4 0.6 0.8 1.0 1.4 1.2

-V_{SD}, SOURCE-DRAIN VOLTAGE (V)

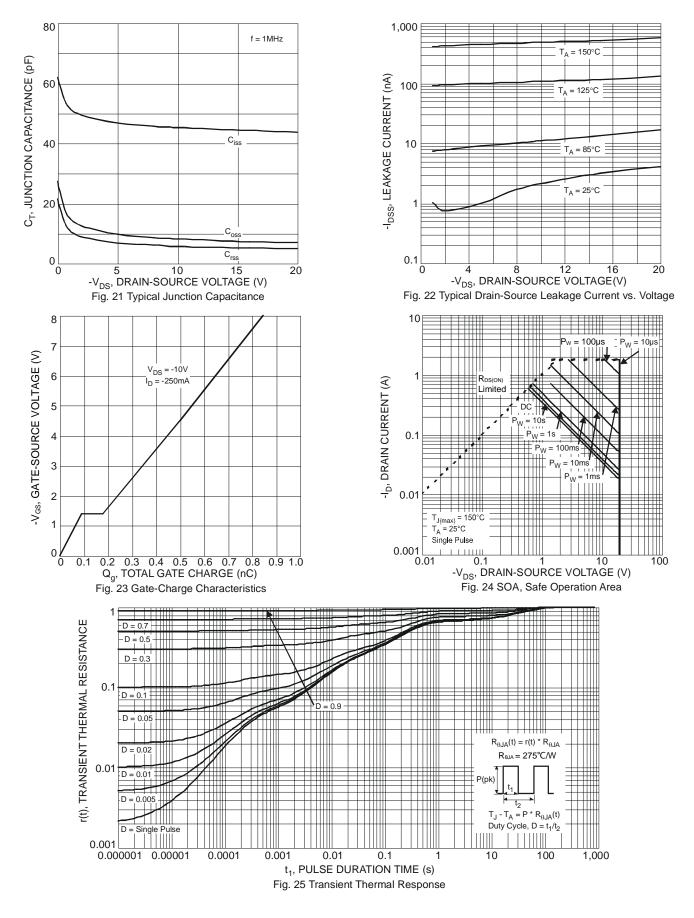
Fig. 20 Diode Forward Voltage vs. Current

Fig. 19 Gate Threshold Variation vs. Junction Temperature

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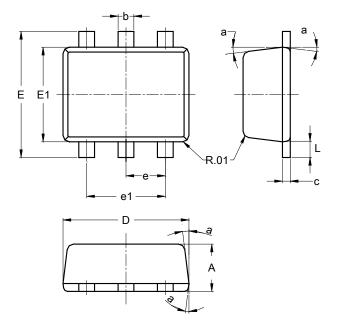




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



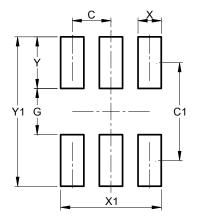


SOT563						
Dim	Min	Max	Тур			
Α	0.55	0.60	0.60			
b	0.15	0.30	0.20			
C	0.10	0.18	0.11			
D	1.50	1.70	1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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